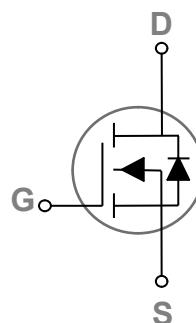
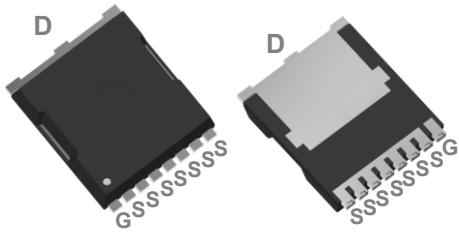


General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

TOLL Pin Configuration



BVDSS	RDS(ON)	ID
150V	5.2mΩ	165A

Features

- 150V, 165A, RDS(ON) = 5.2mΩ@VGS = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

Applications

- Networking
- Load Switch
- LED applications
- Quick Charger

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	150	V
V _{Gs}	Gate-Source Voltage	±20	V
I _D	Drain Current – Continuous ($T_c=25^\circ\text{C}$)	165	A
	Drain Current – Continuous ($T_c=100^\circ\text{C}$)	104	A
I _{DM}	Drain Current – Pulsed ¹	660	A
EAS	Single Pulse Avalanche Energy ²	1350	mJ
I _{AS}	Single Pulse Avalanche Current ²	52	A
P _D	Power Dissipation ($T_c=25^\circ\text{C}$)	430	W
	Power Dissipation – Derate above 25°C	3.44	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction to ambient	---	55	°C/W
R _{θJC}	Thermal Resistance Junction to Case	---	0.29	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$	150	---	---	V
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}=120\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{\text{DS}}=120\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=85^\circ\text{C}$	---	---	10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA

On Characteristics

$\text{R}_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}$, $I_D=30\text{A}$	---	4.4	5.2	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$, $I_D=250\mu\text{A}$	2	3	4	V
gfs	Forward Transconductance	$V_{\text{DS}}=10\text{V}$, $I_D=3\text{A}$	---	17	---	S

Dynamic and switching Characteristics

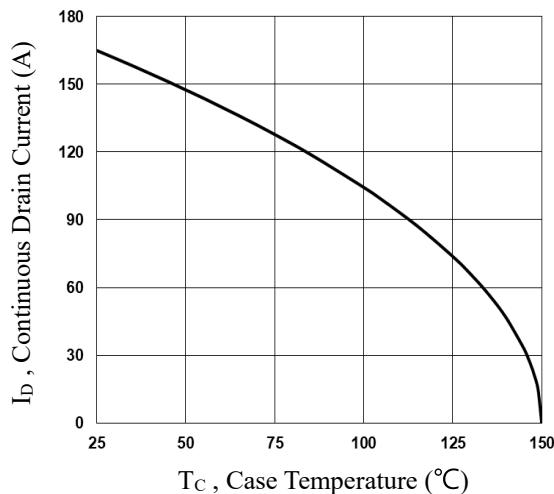
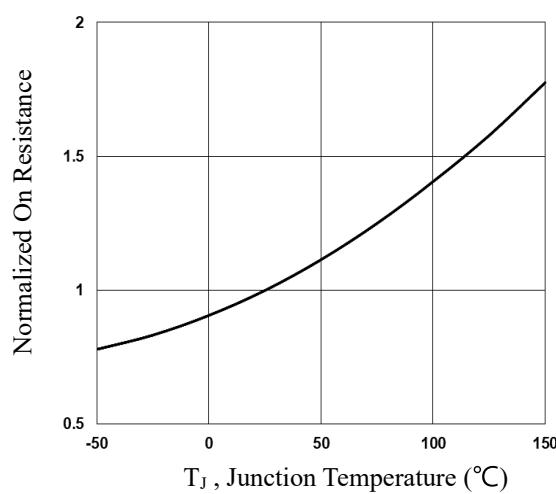
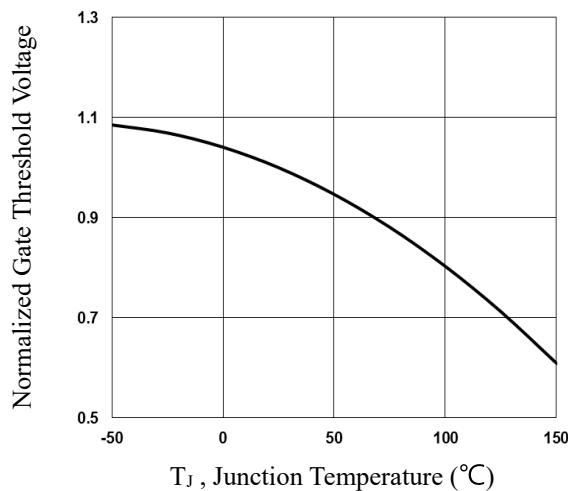
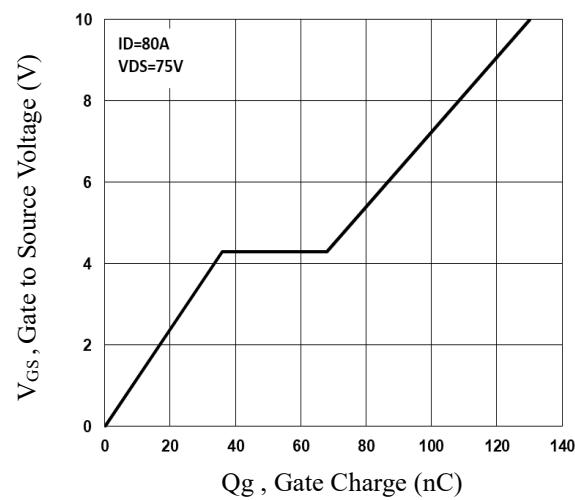
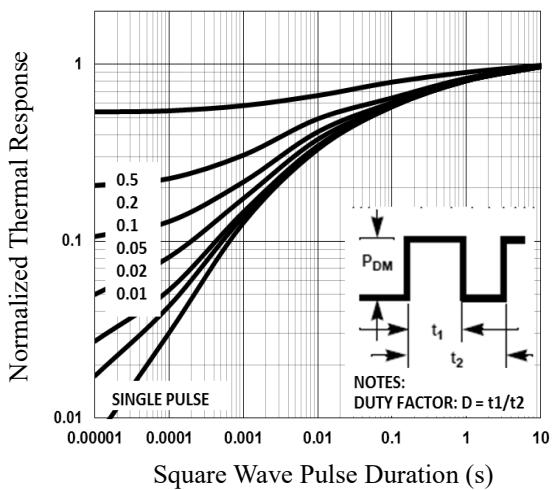
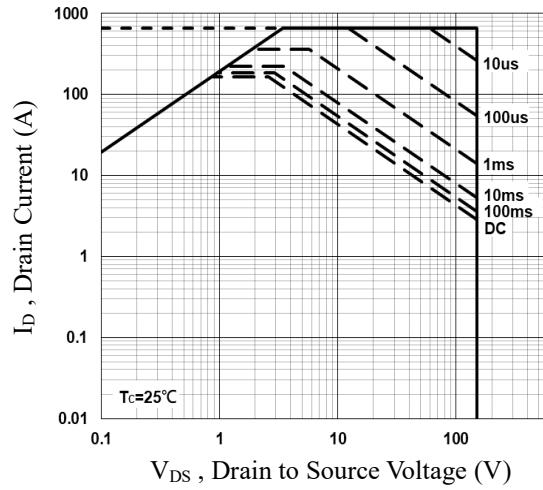
Q_g	Total Gate Charge ^{3, 4}	$V_{\text{DS}}=75\text{V}$, $V_{\text{GS}}=10\text{V}$, $I_D=80\text{A}$	---	130	170	nC
Q_{gs}	Gate-Source Charge ^{3, 4}		---	36	55	
Q_{gd}	Gate-Drain Charge ^{3, 4}		---	32	50	
$T_{\text{d(on)}}$	Turn-On Delay Time ^{3, 4}	$V_{\text{DD}}=75\text{V}$, $V_{\text{GS}}=10\text{V}$, $R_G=6\Omega$ $I_D=80\text{A}$	---	70	105	ns
T_r	Rise Time ^{3, 4}		---	205	310	
$T_{\text{d(off)}}$	Turn-Off Delay Time ^{3, 4}		---	402	600	
T_f	Fall Time ^{3, 4}		---	197	300	
C_{iss}	Input Capacitance	$V_{\text{DS}}=75\text{V}$, $V_{\text{GS}}=0\text{V}$, $F=1\text{MHz}$	---	8525	12500	pF
C_{oss}	Output Capacitance		---	700	1050	
C_{rss}	Reverse Transfer Capacitance		---	25	40	
R_g	Gate resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $F=1\text{MHz}$	---	2.7	---	Ω

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	165	A
I_{SM}	Pulsed Source Current		---	---	330	A
V_{SD}	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$, $I_s=1\text{A}$, $T_J=25^\circ\text{C}$	---	---	1	V
t_{rr}	Reverse Recovery Time	$V_R=100\text{V}$, $I_s=20\text{A}$ $di/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$	---	135	---	ns
Q_{rr}	Reverse Recovery Charge		---	730	---	nC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{\text{DD}}=50\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=1\text{mH}$, $I_{\text{AS}}=52\text{A}$, $R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$.
3. The data tested by pulsed, pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.


Fig.1 Continuous Drain Current vs. Tc

Fig.2 Normalized RDSON vs. Tj

Fig.3 Normalized Vth vs. Tj

Fig.4 Gate Charge Characteristics

Fig.5 Normalized Transient Impedance

Fig.6 Maximum Safe Operation Area

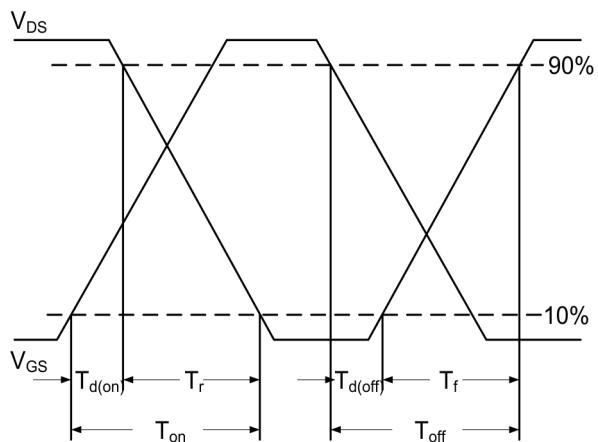


Fig.7 Switching Time Waveform

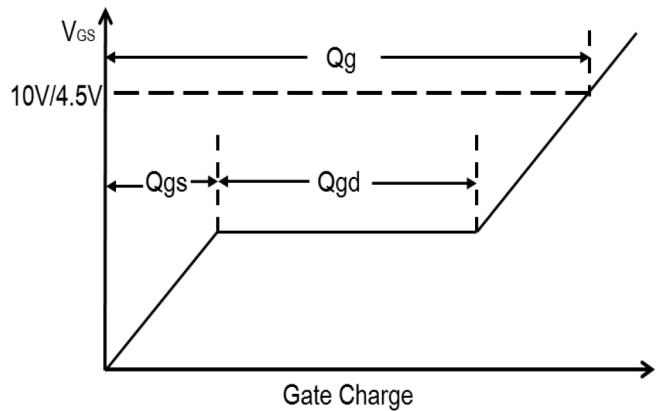
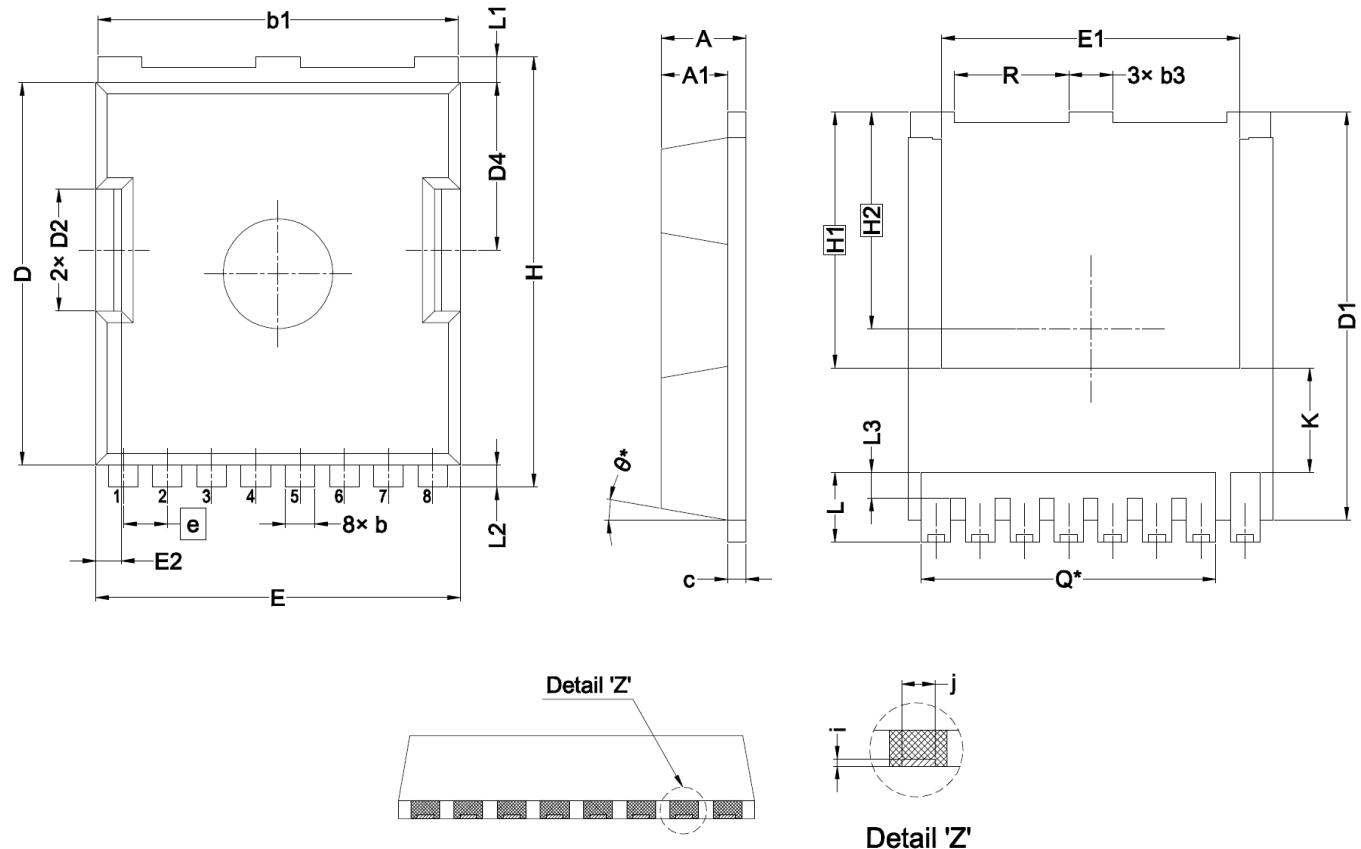
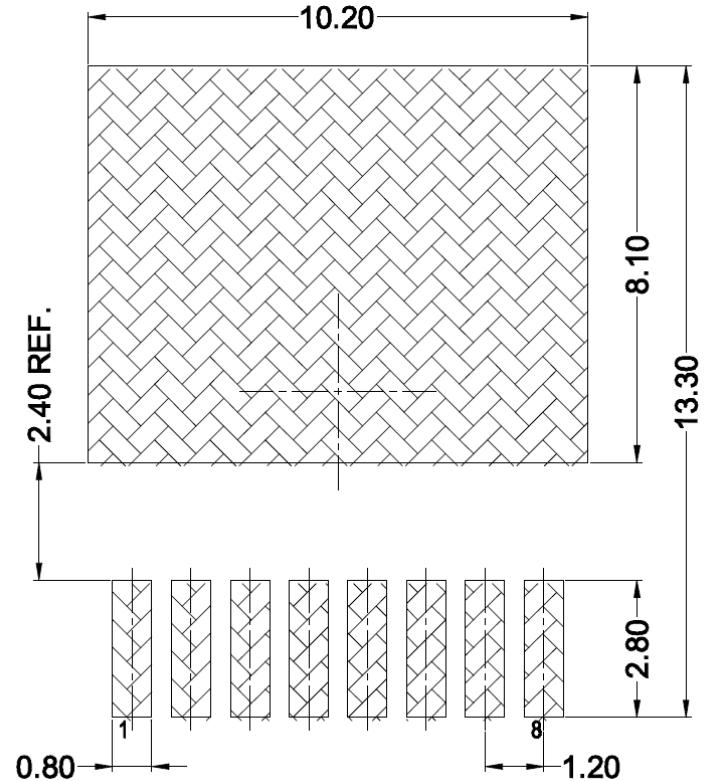


Fig.8 Gate Charge Waveform

TOLL PACKAGE INFORMATION



SYMBOL	mm			SYMBOL	mm		
	MIN	NOM	MAX		MIN	NOM	MAX
A	2.20	2.30	2.40	H	11.58	11.68	11.78
A1	1.70	1.80	1.90	H1	6.95 BSC		
b	0.70	0.80	0.90	H2	5.89 BSC		
b1	9.70	9.80	9.90	i	0.10 REF		
b3	1.10	1.20	1.30	j	0.46 REF		
c	0.40	0.50	0.60	K	2.80 REF		
D	10.28	10.38	10.48	L	1.40	1.90	2.10
D1	10.98	11.08	11.18	L1	0.60	0.70	0.80
D2	3.20	3.30	3.40	L2	0.50	0.60	0.70
D4	4.45	4.55	4.65	L3	0.30	0.70	0.80
E	9.80	9.90	10.00	N	8		
E1	8.00	8.10	8.20	Q	8.00 REF		
E2	0.60	0.70	0.80	R	3.00	3.10	3.20
e	1.20 BSC			θ	10° REF		

TOLL RECOMMENDED LAND PATTERN

unit : mm